# Recovery Time of Silicon Photomultiplier with Epitaxial Quenching Resistors

**JIANG Jia-li**, JIA Jian-quan, ZHAO Tian-qi, LIANG Kun, YANG Ru, HAN De-jun

*Novel Device Laboratory*(*NDL*), *College of Nuclear Science* and Technology, *Beijing Normal University* 

# Outline

- Motivation
- Experimental
- Results
- Discussion
- Conclusion



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2017/5/24

Silicon photomultiplier (SiPM) is a new generation of high sensitive semiconductor photodetector, which consists of multiple pixels of avalanche photodiodes operating in Geiger-mode.

- ✓ High gain, high PDE, high time resolution
- ✓ Single photon counting, excellent photon number resolving ability
- ✓ Insensitive to magnetic field, low operated voltage and low cost

It is gradually replacing the traditional PMT in lowlevel light detection and sensing applications.





#### Analog SiPM:

- SiPM with quenching resistors fabricated at the surface using polysilicon or metal strips (HPK,FBK,ect.)
- SiPM with integrated quenching resistors in epitaxial or bulk silicon

#### **EQR SiPM:**

- Epitaxial silicon layer below p-n junction as the quenching resistor
- A large fill factor with small cell size
- High PDE can be obtained while retaining large dynamics range
- The fabrication steps for quenching resistors on the surface are omitted

The EQR SiPM firstly developed by NDL in 2010 (https://doi.org/10.1016/j.nima.2010.04.040)



Schematic structure of EQR SiPM



 $3 \times 3 mm^2 EQR SiPM$ 

Device type : P-on-N Active area :  $3 \times 3mm^2$ Pixel size :  $10\mu m$ Charge time constant : ~3ns Number of microcells : ~ $9 \times 10^4$ Gain : ~ $2 \times 10^5$ Dark count rate : 7MHz Crosstalk : 8% Peak PDE : 31% at 420nm

Small RC time constant for the APD cells, short recovery time and fast time counting rate can be expected.



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#### **Recovery time of SiPM**

**Definition :** The time needed to recharge a pixel after a breakdown has been quenched due to the finite time taken to quench the avalanche then reset the diode voltage to its initial bias value.





Shortening recovery time for the high flux photons detection and fast photon counting applications



If the counting rate of SiPM is increased to hundreds MHz or GHz, it would be expected to be applied to photon reflectometry, quantum random number generators, etc.



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#### Method: Double light pulse method: for measuring Overall recovery time and partial recovery time

Waveform analysis method: for recovery time of Single photon pulse

Principle: Photon reach to detector surface during voltage recovery process, its signal amplitude is reduced.

$$A_2/A_1 = y_0 + A * \exp((-x/\Delta t))$$

Red dashed lines shows the signal when the 2 path is blocked, blue dashed lines shows the signal when the 1 path is blocked, black line the signal when both paths are connected.





## Double light pulse method



Picosecond pulsed with pulse width of 32 ps Lecroy oscilloscope: waverunner 610zi, with a bandwidth of 4 GHz

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## Waveform analysis method



If an afterpulse is caused during this recovery time, as the bias voltage is lower than *V*<sub>op</sub>, its pulse height is less than 1p.e. should be observed. Thus, by tracing the interval time and the amplitude of afterpulsing, recovery curve can be obtained.



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### Results

#### **Recovery time of 3mm device**



Total ~90000 pixels were fired, the overall recovery time of the device was ~31ns; the number of fired pixels were controlled to be about 2000, the device recovery time was decreased greatly to ~6.5ns;

## Results

#### **Recovery time of 3mm device**



The recovery time of **one fired pixel** obtained by extracting afterpulsing under dark conditions and fitting out the recovery curve was ~ **3ns** 

The recovery time increases with the number of fierd cells.



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## Results

#### Recovery time of 1.4mm device



The device with  $1.4 \times 1.4$  mm<sup>2</sup> active area and  $10\mu$ m pixel size, the device recovery time was ~15ns while total ~20000 pixels were fired

The recovery time increases with the device area.



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The recovery time of the device is strongly dependent on the active area of device and the number of fired pixels, the recovery time increases with the number of fierd cells and device area.



### Discussion

Reason 1 : signal transmission time delay

#### **RC transmission line:**

 $P++\rightarrow Rg$ total  $C\rightarrow Cg$ 

Reason 2 : readout electronics

#### **Impedance matching**

The value of signal capacitance and load resistors

Reason 3 : pixels can't possibly be fired synchronously when they are bias on



equivalent electrical mode of EQR-SiPM



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## Conclusion

- Recovery time of EQR-SiPM is increasing with the increase of the number of fired pixels.
- The device with same microcell size, its overall recovery time increases with the device area.
- Signal circuit, RC transmission line and charge transport mode affect the pulse waveform.
- Improve direction: reduce RC transmission lines and Optimized readout circuit



# Thank you for your attention!

#### Development of P-on-N Type Silicon Photomultiplier with Epitaxial Quenching Resistors Type: Poster Track: Photon detectors

Silicon photomultiplier (SiPM) is alternative to conventional PMT in various applications due to its high photon detection efficiency (PDE), excellent resolution for single photon detection, insensitivity to magnetic field, low operating voltage and convenience for integration, etc. SiPM with epitaxial quenching resistor (EQR SiPM) is one of the main SiPM technologies, which can effectively reduce ... More

Presented by Mr. Jianquan JIA

Tel: +86-10-62207419 E-mail: <u>info@ndl-sipm.net</u> URL: http://www.ndl-sipm.net/



